



DNP1102F Surface Mount IRED/Right Angle Type

Features

PackageRight Angle type, Water clear epoxyProduct features• Outer Dimension 3.0 x 1.0 x 2.5mm (L x W x H) • Total Output Power : 2mW TYP. (lg=20mA) • Lead-free soldering compatible • RoHS compliantPeak Wavelength880nmPeak Wavelength880nmHalf Intensity Angle $θ x = 35$ deg, $θ y = 110$ deg.Die materialsGaAlAsRank grouping parameterSorted by radiant intensity per rank tapingAssembly methodAuto pick & place machine (Auto Mounter)Soldering methodsReflow soldering and manual soldering * XPlease refer to Soldering Conditions about soldering.Taping and reel3,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: \$ 180mmESD2kV (HBM)		
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ESD 2kV (HBM)	Taping and reel	
	ESD	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

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Item	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pd	80	mW
Forward Current	I _F	50	mA
Pulse Forward Current ^{**}	I _{FRM}	300	mA
Derating (Ta=25℃ or higher)	⊿ I _F	0.67	mA/°C
	⊿ I _{FRM}	4	mA/°C
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-30~+85	C
Storage Temperature	T _{stg}	-40~+100	C

※1 IFRM Measurement condition : Pulse Width ≤ 100μ s, Duty ≤ 1/100

Electro-Optical Characteristics

2006.8.31

ltem		Symbol	Characteristics		Unit	
nem	Conditions	5 yilliool	Characteristics		Ont	
Forward Voltage	L = 20m A	V _F	TYP.	1.35	v	
Forward voltage	I _F =20mA		MAX.	1.6	v	
Reverse Current	V _R =5V	I _R	MAX.	100	μA	
		I _E -	MIN.	1.5	mW/sr	
Radiant Intensity	I _F =20mA		TYP.	3		
Total Output Power	I _F =20mA	Ро	TYP.	2	mW	
Peak Wavelength	I _F =20mA	λp	TYP.	880	nm	
Spectral Half-width	I _F =20mA	⊿λ	TYP.	40	nm	
		2 <i>0</i> 1/2	ТҮР.	35(θ x)	deg.	
Half Intensity Angle	I _F =20mA			110(<i>θ</i> y)		
	$I_{F}=20 \text{mA}_{DC} \pm 5 \text{mA},$	fc	MIN.	-	MHz	
Cut-off Frequency	-3db from 0.1MHz		TYP.	12		
Response Time	I _F =20mA	tr/tf	TYP.	30	ns	

Absolute Maximum Ratings

(Ta=25°C)

DNP1102F

Surface Mount IRED/Right Angle Type

Pb-free HEAT

(Ta=25°C)

DNP1102F

Surface Mount IRED/Right Angle Type

Pb-free HEAT

STANLEY ELECTRIC CO., LTD.

Radiant Intensity Rank

Rank	l _E (m)	Condition	
Kalik	MIN.	MAX.	Contraction
A	1.5	3.0	
В	2.1	4.2	
С	3.0	6.0	I _F = 20mA
D	4.2	8.4	
E	6.0	12.0	

Please contact our sales staff concerning rank designation.

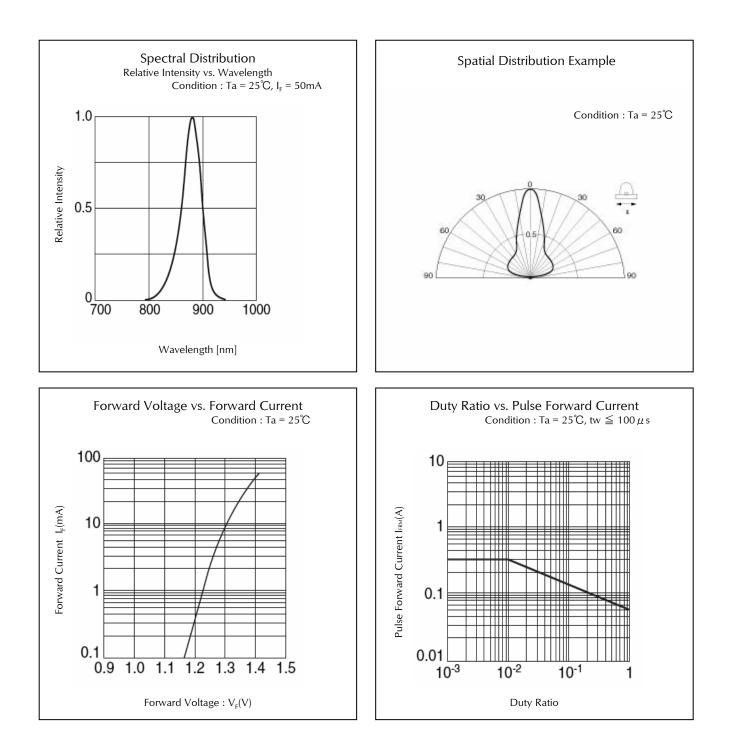


(Ta=25°C)





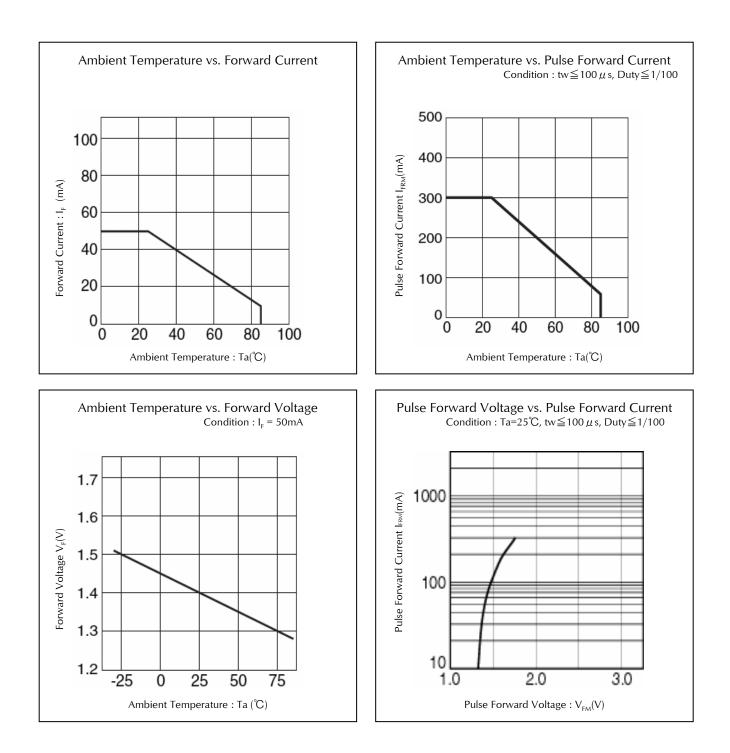
Technical Data







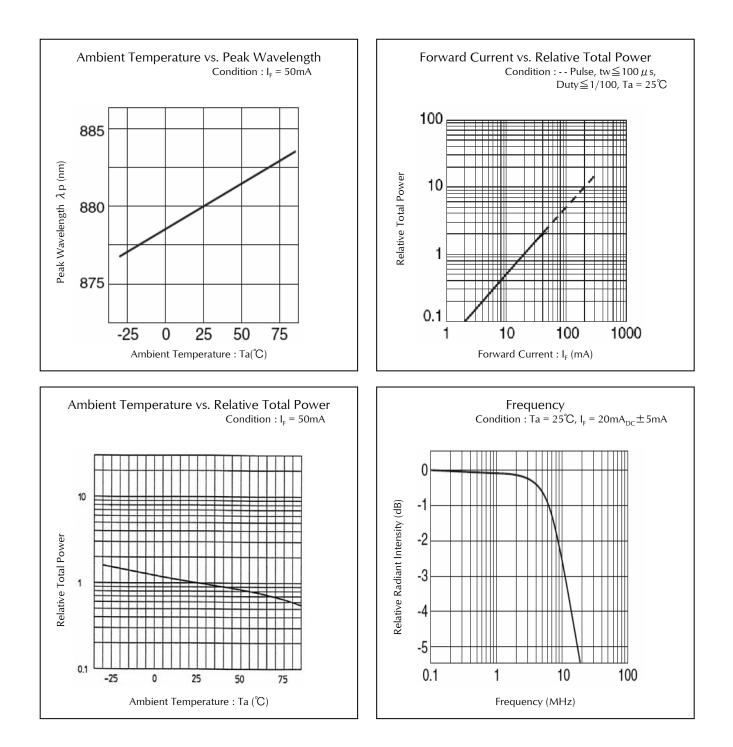
Technical Data







Technical Data

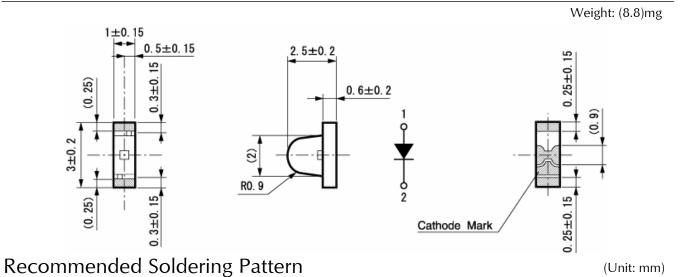




Pb-free HEAT DNP1102F Surface Mount IRED/Right Angle Type

Package Dimensions





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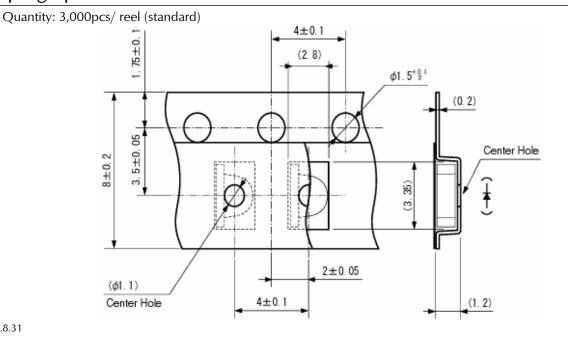
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(Unit: mm)

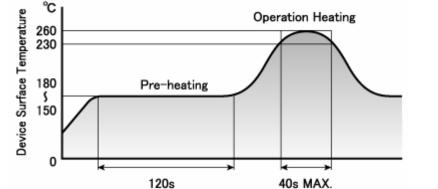
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Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350 ℃	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)



DNP1102F Pb-free HEAT

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Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1 <i>,</i> 000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°℃~180°C 120s Operating Heating 230°C Min. Peak temperature 260°C	Twice	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$T_a = 60 \pm 2^{\circ}C$, RH = 90 ± 5%	1 <i>,</i> 000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1 <i>,</i> 000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1 <i>,</i> 000 h	0/25
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

ltems	Symbols	Conditions	Failure criteria
Radiant Intensity	Ι _Ε	IF Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	 R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking



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